



Sigfox Monarch Module WSG309S

Compact-sized
With Ultra-low Power
Consumption

WSG309S_IPEX

WSG309S_RF_PAD







Sigfox Support (Monarch)



RC1/2/3/4/5/6/7



AT Commands



Extended Temperature Range: -30°C to +85°C



Ultra-Low Power Consumption (6.17uA @ sleep mode)

WSG309S RC 1/2/3/4/5/6/7 is a Sigfox +BT5.0 modem module for the low power wide area network (LPWAN) market. It is designed with STM's system S2-LP+BLUENRG248 MCU

The module was designed for high performance, high quality, low cost, small form factor and most importantly. The Sigfox application is running on BLUENRG2 MCU at high efficiency executed at high efficiency using its internal 32bit core Cortex-M0 processor.

Every module is preloaded with Sigfox application software, module specific ID/KEY/PAC as referring to Sigfox network system. The preloaded software also includes a bootloader which allows software update or future user application development.



◆ SIGFOX VERIFIED CERTIFICATE



Sigfox Verified™ Certificate M_004E_0C85_01

Congratulations LiteOn, the following product is now Sigfox Verified™ certified:



PRODUCT MODEL NAME:	WSG309S
RADIO CONFIGURATION:	RC1, RC2, RC3, RC4, RC5, RC6, RC7
	CORP-13447_RC1_UDL_MON
	CORP13447_RC2_UDL_MON
(8.0%) (1.0%) (1.0%)	CORP-13447_RC3C_UDL_MON
TEST REPORT:	CORP13447_RC4_UDL_MON
	CORP-13447_RC5_UDL_MON_
	CORP13447_RC6_UDL_MON
	60394140-001
LAYOUT VERSION:	V01
SCHEMATIC VERSION:	VOT
BOM VERSION:	V01
FIRMWARE VERSION:	V2.1.0.2
SIGFOX LIB:	V2.8.1_FDL_MON_ADDON_V0.6.0
MESSAGE ROLLOVER COUNTER:	4096
SIGFOX REFERENCE:	BUIL-917
CERTIFICATION DATE:	15/07/2020
SIGFOX FEATURES:	
DOWNLINK	1
PAYLOAD ENCRYPTED	✓
MONARCH	✓

This certificate is valid for this product only. Any change to the certified product has to be reported to Sigfox as it may lead to a renewal of the RF & protocol Tests.

The Sigfox Verified™ logo must be used in respect of Sigfox branding guidelines.





Sigfox Ajead Office: 425 rue Jean Rostand, 31670 Labége, FRANCE www.sigfox.com



General Feature

 General Sigfox module for Smart City, Smart Agriculture, Smart Industry, IOT Application

Compact Form Factor: 28.5 x 16.5 x 3.0 mm59 Pin Stamp Pad for PCB SMT mounting

Interface : I2C*1/UART*1/GPIO*12/ADC*2/SWD*1

■ Temperature range: -30°C to +85°C

■ Supply voltage: 2.1 ~ 3.6V

Preloaded Sigfox application with ID/KEY/PAC

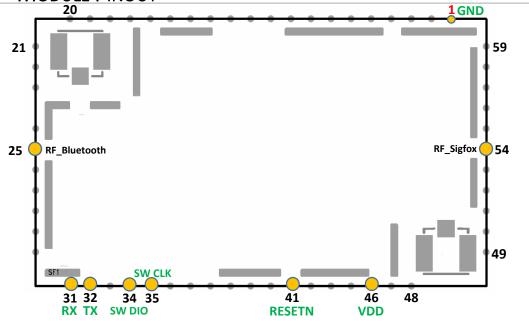
Bluetooth Profile Support list: GAP, GATT, ATT, SM, L2CAP

Product Specifications

WSG309S			
Standard	Sigfox Network System	Bluetooth5.0	
Interface	I2C/UART/GPIO/ADC/SWD/DIO		
Transmit Output Power	22dBm(RC2/4) 14dBm(RC1/6/7) 13dBm(RC3/5)	8dBm	
Data Rate	Uplink: 100bps Downlink: 600bps	1Mbps	
Modulation Techniques	Uplink - DBPSK Downlink – GFSK	GFSK	
Frequency bands	RC 1/2/3/4/5/6/7	2400 to 2483.5MHz	
Operating Voltage	2.1 ~ 3.6V		
Operating Temperature	-30 ~ 85 degree C		
Current consumption	121mA Tx at 22dBm (peak current with Sigfox packet transmission) 33mA Tx at 14dBm (peak current with Sigfox packet transmission) 31mA Tx at 13dBm (peak current with Sigfox packet transmission) 22mA Tx at 4dBm with BT packet transmission 6.17uA at sleep mode		







PIN DEFINITION

No.	Name	I/O	Function	
1	GND	GND	Ground	
2	GND	GND	Ground	
3	GND	GND	Ground	
4	GND	GND	Ground	
5	GND	GND	Ground	
6	S2-LP SDO	I/O	Connect to BlueNRG-2_DIO3(Suggest to floating)	
7	S2-LP SDI	I/O	Connect to BlueNRG-2_DIO2(Suggest to floating)	
8	S2-LP SCLK	I/O	Connect to BlueNRG-2_DIO0(Suggest to floating)	
9	S2-LP CSN	I/O	Connect to BlueNRG-2_DIO20(Suggest to floating)	
10	DIO1	I/O	BlueNRG-2_DIO1	
11	DIO17	I/O	BlueNRG-2_DIO17	
12	S2-LP GPIO2	I/O	Connect to BlueNRG-2_DIO19(Suggest to floating)	
13	S2-LP GPIO3	I/O	Connect to BlueNRG-2_DIO21(Suggest to floating)	
14	S2-LP SDN	I/O	Connect to BlueNRG-2_DIO25(Suggest to floating)	
15	GND	GND	Ground	
16	GND	GND	Ground	
17	DIO16	I/O	BlueNRG-2_DIO16	
18	DIO15	I/O	BlueNRG-2_DIO15	
19	ADC1	I/O	BlueNRG-2_ADC1	
20	ADC2	I/O	BlueNRG-2_ADC2	
21	GND	GND	Ground	
22	DIO14	I/O	BlueNRG-2_DIO14	
23	GND	GND	Ground	
24	GND	GND	Ground	
25	BT Antenna	RF	Only work on WSG309S_RF_PAD version	

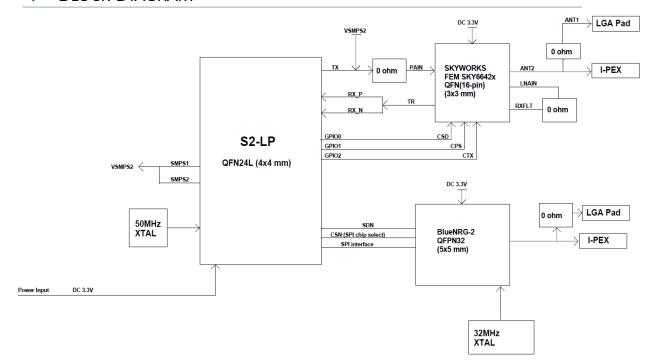


♦ PIN DEFINITION

No.	Name	I/O	Function	
26	GND	GND	Ground	
27	GND	GND	Ground	
28	GND	GND	Ground	
29	DIO13	I/O	BlueNRG-2_DIO13	
30	GND	GND	Ground	
31	UART_RX	I/O	BlueNRG-2_DIO11 (115200bps)	
32	UART_TX	I/O	BlueNRG-2 DIO8 (115200bps)	
33	DIO7	I/O	BlueNRG-2_DIO7 (boot load module internal pull low 100K)	
34	JTMS-SWTDIO	I/O	SW DIO (BlueNRG-2_DIO10) SWD data signal (MCU debugger and programing)	
35	JTMS-SWTCK	I/O	SW CLK (BlueNRG-2_DIO9) SWD clock signal (MCU debugger and programing)	
36	DIO12	I/O	BlueNRG-2_DIO12	
37	DIO6	I/O	BlueNRG-2_DIO6	
38	DIO18	I/O	BlueNRG-2_DIO18	
39	NC		No connect on module	
40	I2C2_DAT	I/O	BlueNRG-2_DIO5 (module internal pull high 10K)	
41	RESETN	I/O	BlueNRG-2 RESETN (module internal pull high 100k, Low Active)	
42	NC		No connect on module	
43	I2C2_CLK	I/O	BlueNRG-2_DIO4 (module internal pull high 10K)	
44	XI	I	Reserve for external RTC 32.768k	
45	XO	0	Reserve for external RTC 32.768k	
46	VDD	Р	Power input	
47	GND	GND	Ground	
48	GND	GND	Ground	
49	GND	GND	Ground	
50	GND	GND	Ground	
51	GND	GND	Ground	
52	GND	GND	Ground	
53	GND	GND	Ground	
54	Sigfox Antenna	RF	Only work on WSG309S_RF_PAD version	
55	GND	GND	Ground	
56	GND	GND	Ground	
57	GND	GND	Ground	
58	GND	GND	Ground	
59	GND	GND	Ground	

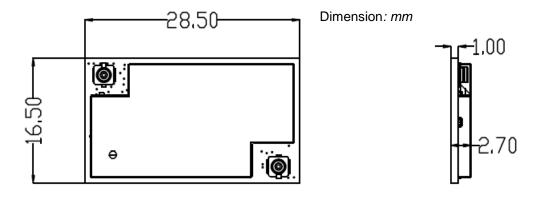


BLOCK DIAGRAM



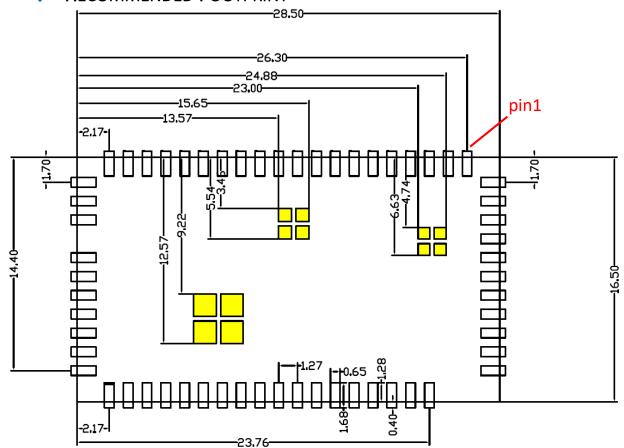
♦ MODULE DIMENSION



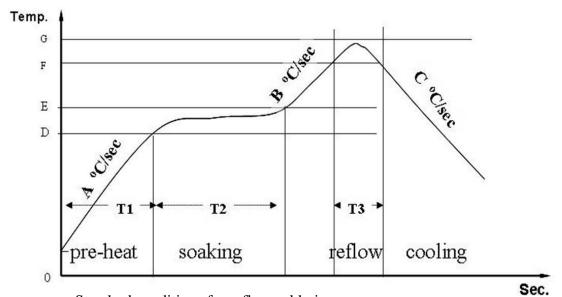


LITEON®

◆ RECOMMENDED FOOTPRINT



◆ RECOMMENDED REFLOW PROFILE

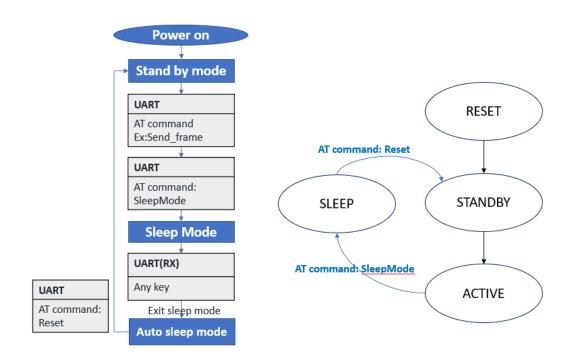


Standard conditions for reflow soldering:

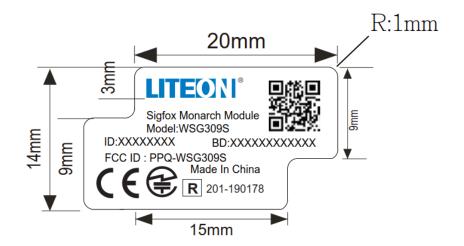
- a. Pre-heating Ramp (A) (Initial temperature: 150°C): 1~2.5°C/sec;
- b. Soaking Time (T2) (150°C~180°C): 60sec~100sec;
- c. Peak Temperature (G): 230~250°C;
- d. Reflow Time (T3) (>220°C): 30~60 sec;
- e. Ramp-up Rate (B): 0~2.5°C/ sec;
- f. Ramp-down Rate (C): 1~3°C/ sec.



◆ FLOW OF STANDBY/SLEEP MODE



♦ LABEL DRAWING



备注:

条码使用二维码QR CODE 等级为B级以上,尺寸为5*5mm 條碼顯示內容為三行(由業務提供) XXXXXXXX(8碼ID) XXXXXXXXXXXXXXXXXX(16碼PAC) XXXXXXXXXXXXXXXXX(12碼BD)



CHANGE LIST

Rev	Date	Author	Change List
V1.0	2019.03.26	Kaysa Lee	Preliminary (official)
V1.1	2019.06.28	Kelly Hsu	Update Sigfox Verified Certificate
V1.2	2019.08.02	Kelly Hsu	Modify Module Pinout and Pin Definition Add Flow of Standby/Sleep mode Add Label Drawing
V1.3	2019.12.18	Kelly Hsu	Update Sleep Mode Power Consumption Add Bluetooth Profile Support List Update Product Specifications Update AT Command List Update Label Drawing
V1.4	2020.05.04	Kelly Hsu	Modify Pin Definition
V1.5	2020.08.13	Kelly Hsu	Modify Sigfox Verified Certificate